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Silicon N-Channel MOS FET



ADE-208-1317 (Z) 1st. Edition Mar. 2001

#### Application

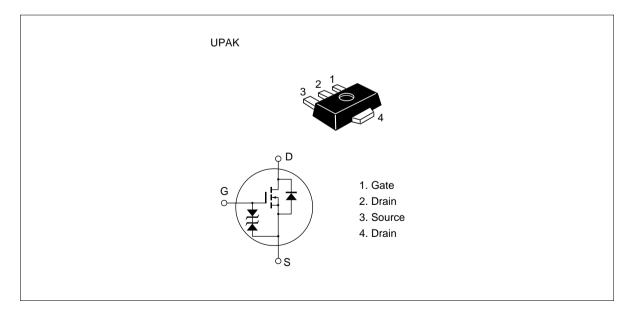
Low frequency amplifier

High speed switching

#### Features

- Low on-resistance
- High speed switching
- 4 V Gate drive device can be driven from 5 V source
- Suitable for switchingregulator, DC-DC converter

#### Outline



#### Absolute Maximum Ratings (Ta = $25^{\circ}$ C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	60	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	2	A
Drain peak current	l★1 D(pulse)	4	A
Body to drain diode reverse drain current	I <sub>DR</sub>	2	А
Channel power dissipation	Pch*2	1	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes 1. PW  $\leq$  100 µs, duty cycle  $\leq$  10 %

2. Value on the alumina ceramic board (12.5 x 20 x 0.7 mm)

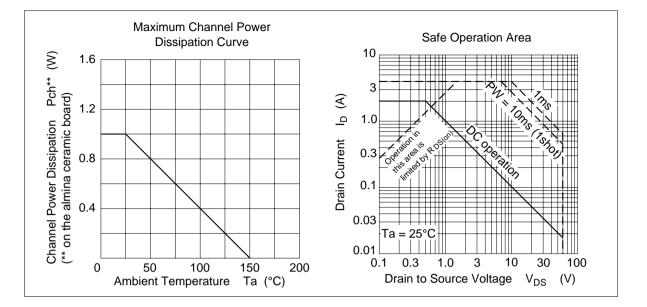
3. Marking is "KY".

#### **Electrical Characteristics** (Ta = 25°C)

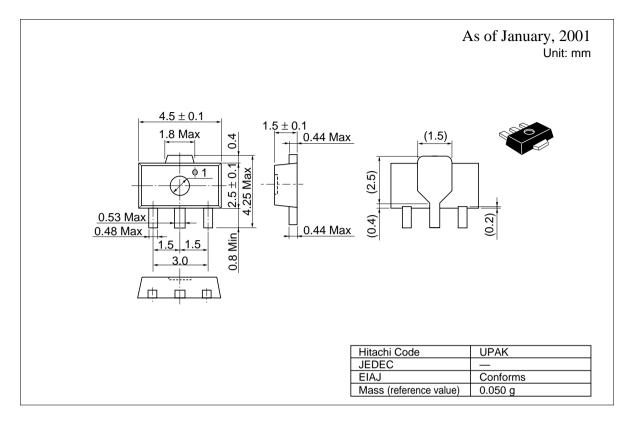
Item	Symbol	Min	Тур	Мах	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	60	_	_	V	$I_{\rm D} = 10 \text{ mA}, V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1	—	2	V	$V_{\rm DS} = 10 \text{ V}, \text{ I}_{\rm D} = 1 \text{ mA}$
Drain to source cutoff current	I <sub>DSS</sub>	_	_	10	μA	$V_{\rm DS} = 50 \ V, \ V_{\rm GS} = 0$
Gate to source cutoff current	I <sub>GSS</sub>	_	_	±5	μA	$V_{GS} = \pm 15 \text{ V}, V_{DS} = 0$
Static drain to source on state resistance	$R_{\text{DS(on)1}}$	_	0.3	0.45	Ω	$V_{GS} = 10 V$ $I_{D} = 1 A^{*1}$
Static drain to source on state resistance	$R_{\text{DS(on)2}}$	—	0.4	0.60	Ω	$V_{GS} = 4 V$ $I_{D} = 1 A^{*1}$
Forward transfer admittance	y <sub>fs</sub>	0.9	1.7	—	S	$V_{DS} = 10 V$ $I_{D} = 1 A^{*1}$
Input capacitance	Ciss	_	140	_	pF	V <sub>DS</sub> = 10 V
Output capacitance	Coss	_	75	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	20	_	pF	f = 1 MHz
Turn on time	t <sub>on</sub>	_	18	_	ns	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A}^{*1}$
Turn off time	t <sub>off</sub>	_	80		ns	R <sub>L</sub> = 30 Ω

Note 1. Pulse Test

See characteristics curves of 2SK975



#### **Package Dimensions**



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